

## Features

- ESD Protect for 2 Lines with Bi-directional
- Provide ESD protection for the protected line to IEC 61000-4-2 (ESD) ±15kV (air), ±15kV (contact)
  IEC 61000-4-4 (EFT) 40A (5/50ns)
  Cable Discharge Event (CDE)
- Small SOT23-3L package saves board space
- Protect two I/O lines or two power lines
- Fast turn-on and Low clamping voltage
- Low operating voltage: 5V
- Solid-state silicon-avalanche and active circuit triggering technology
- Green Part

### **Applications**

- Computer Interfaces Protection
- Microprocessors Protection
- Serial and Parallel Ports Protection
- Control Signal Lines Protection
- Power lines on PCB Protection
- Latchup Protection

### Description

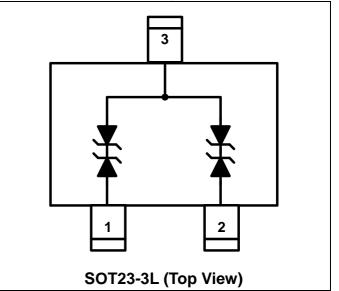
AZ5125-02S is a design which includes two bi-directional ESD rated clamping cells to protect two power lines, or two control lines, or two low speed data lines in an electronic systems. The AZ5125-02S has been specifically designed to protect sensitive components which are connected to power and control lines from over-voltage damage and latch-up caused by Electrostatic Discharging (ESD), Electrical Fast Transients (EFT), and Cable Discharge Event (CDE).

AZ5125-02S is a unique design which includes proprietary clamping cells in a single package. During transient conditions, the proprietary clamping cells prevent over-voltage on the power lines or control/data lines, protecting any downstream components.

AZ5125-02S is bi-directional and may be used on lines where the signal swings above and below ground.

AZ5125-02S may be used to meet the ESD immunity requirements of IEC 61000-4-2, Level 4 ( $\pm$ 15kV air,  $\pm$ 8kV contact discharge).

Circuit Diagram / Pin Configuration





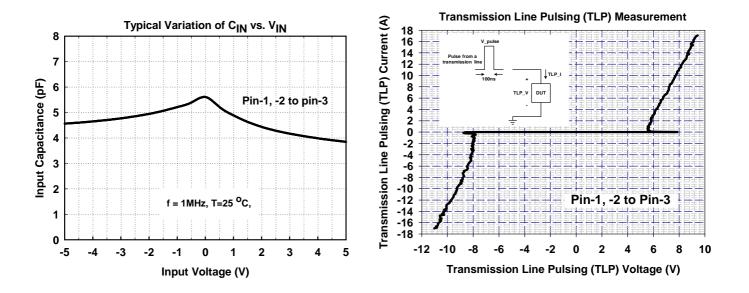
## **SPECIFICATIONS**

ABSOLUTE MAXIMUM RATINGS				
PARAMETER	PARAMETER	RATING	UNITS	
Operating Supply Voltage (pin-1,-2 to pin-3)	V <sub>DC</sub>	±5.8	V	
ESD per IEC 61000-4-2 (Air)	V	±15	kV	
ESD per IEC 61000-4-2 (Contact)	V <sub>ESD</sub>	±15	KV	
Lead Soldering Temperature	T <sub>SOL</sub>	260 (10 sec.)	℃	
Operating Temperature	T <sub>OP</sub>	-55 to +85	Co	
Storage Temperature	T <sub>STO</sub>	-55 to +150	℃	

ELECTRICAL CHARACTERISTICS						
PARAMETER	SYMBOL	CONDITIONS	MINI	TYP	MAX	UNITS
Reverse Stand-Off	V <sub>RWM</sub>	T=25 ℃	-5		5	V
Voltage	<b>∨</b> RWM					
Reverse Leakage	1	V <sub>RMM</sub> = ±5V, T=25 °C.			1	
Current	l <sub>Leak</sub>	$v_{\text{RVM}} = \pm 3v, T = 23$ C.			I	μA
Reverse	V <sub>BV</sub>	I <sub>BV</sub> = 1mA, T=25 ℃.	5.8		9	V
Breakdown Voltage	VBV	$I_{BV} = 111A, T = 23 C.$				
ESD Clamping	V	IEC 61000-4-2 +6kV, T=25 °C,		44 E		V
Voltage	$V_{ESD_{CL}}$	Contact mode		11.5		V
Channel Input	C	$V_{R}$ = 0V, f = 1MHz, T=25 °C.		6	8	ъЕ
Capacitance	C <sub>ℕ</sub>			0	0	pF



## **Typical Characteristics**



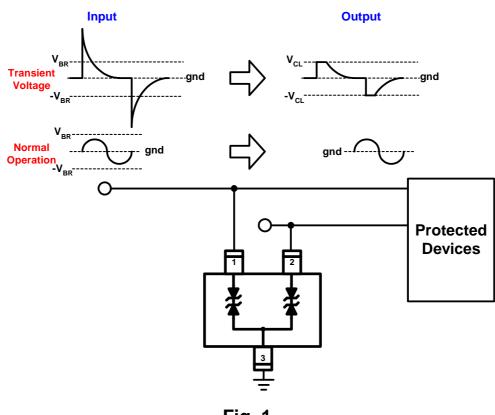


#### **Applications Information**

The AZ5125-02S is designed to protect two lines against System ESD/EFT/Cable-Discharging pulses by clamping them to an acceptable reference. It provides bi-directional protection.

The usage of the AZ5125-02S is shown in Fig. 1. Protected lines, such as data lines, control lines, or power lines, are connected at pin 1 and pin 2 respectively. The pin 3 is connected to a ground plane on the board. In order to minimize parasitic inductance in the board traces, all path lengths connected to the pins of AZ5125-02S should be kept as short as possible. In order to obtain enough suppression of ESD induced transient, good circuit board is critical. Thus, the following guidelines are recommended:

- Minimize the path length between the protected lines and the AZ5125-02S.
- Place the AZ5125-02S near the input terminals or connectors to restrict transient coupling.
- The ESD current return path to ground should be kept as short as possible.
- Use ground planes whenever possible.
- NEVER route critical signals near board edges and near the lines which the ESD transient easily injects to.

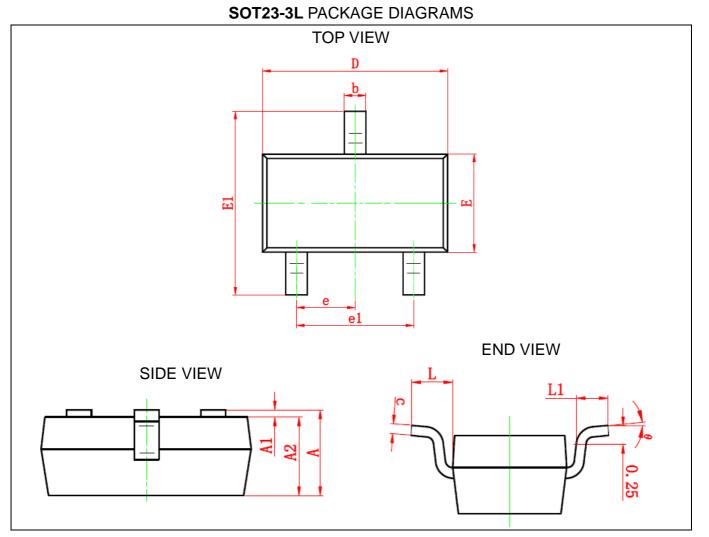




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### **Mechanical Details**

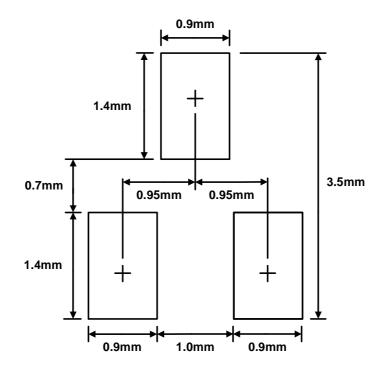


#### PACKAGE DIMENSIONS

Symbol	Dimensions	In Millimeters	Dimensions In Inches		
Symbol	Min	Max	Min	Max	
A	0.900	1.150	0.035	0.045	
A1	0.000	0.100	0.000	0.004	
A2	0.900	1.050	0.035	0.041	
b	0.300	0.500	0.012	0.020	
С	0.080	0.150	0.003	0.006	
D	2.800	3.000	0.110	0.118	
E	1.200	1.400	0.047	0.055	
E1	2.250	2.550	0.089	0.100	
е	0.950 TYP		0.037 TYP		
e1	1.800	2.000	0.071	0.079	
L	0.550 REF		0.022 REF		
L1	0.300	0.500	0.012	0.020	
θ	0°	8°	0°	6°	



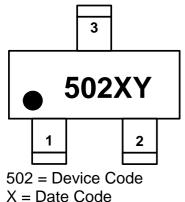
# LAND LAYOUT



Notes:

This LAND LAYOUT is for reference purposes only. Please consult your manufacturing partners to ensure your company's PCB design guidelines are met.

### **MARKING CODE**



Part NumberMarking CodeAZ5125-02S502XY

#### **Ordering Information**

Y = Control Code

PN#	Material	Туре	Reel size	MOQ/internal box	MOQ/carton
AZ5125-02S.R7G	Green	T/R	7 inch	4 reel=12,000/box	6 box=72,000/carton



## **Revision History**

Revision	Modification Description		
Revision 2009/04/22	Preliminary Release.		
Revision 2009/08/19	Formal Release.		
Revision 2011/07/28	1. Update the Company Logo.		
	2. Add the Ordering Information.		